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July 2014



FDMA1025P Dual P-Channel PowerTrench[®] MOSFET -20V, -3.1A, 155mΩ

Features

- Max $r_{DS(on)}$ = 155m Ω at V_{GS} = -4.5V, I_D = -3.1A
- Max r_{DS(on)} = 220mΩ at V_{GS} = -2.5V, I_D = -2.3A
- Low profile 0.8mm maximum in the new package MicroFET 2X2 mm
- RoHS Compliant
- Free from halogenated compounds and antimony oxides



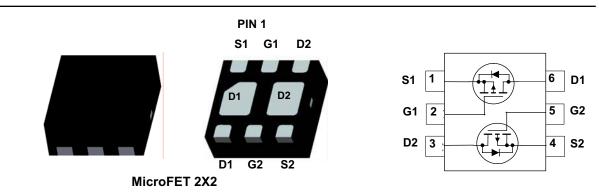
General Description

This device is designed specifically as a single package solution for the battery charge switch in cellular handset and other ultra portable applications. It features two independent P-Channel MOSFETs with low on-state resistance for minimum conduction losses. When connected in the typical common source configuration, bi-directional current flow is possible.

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and well suited to linear mode applications.



DC - DC Conversion



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage		-20	V	
V _{GS}	Gate to Source Voltage		±12	V	
ID	Drain Current -Continuous	(Note 1a)	-3.1		
	-Pulsed		-6	— A	
P _D	Power Dissipation for Single Operation	(Note 1a)	1.4	w	
	Power Dissipation	(Note 1b)	0.7		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

R _{0JA}	Thermal Resistance Single Operation, Junction to Ambient	(Note 1a)	86	
R _{0JA}	Thermal Resistance Single Operation, Junction to Ambient	(Note 1b)	173	°C/W
$R_{\theta JA}$	Thermal Resistance Dual Operation, Junction to Ambient	(Note 1c)	69	0,00
R_{\thetaJA}	Thermal Resistance Dual Operation, Junction to Ambient	(Note 1d)	151	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
025	FDMA1025P	MicroFET 2X2	7"	8mm	3000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250μA, V _{GS} = 0V	-20			V
∆BV _{DSS}	Breakdown Voltage Temperature			44		
ΔT_J	Coefficient	$I_D = -250\mu A$, referenced to 25°C		14		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16V,		-1		
		$V_{GS} = 0V$ $T_J = 125^{\circ}C$			-100	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 12V, V_{DS} = 0V$			±100	nA
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-0.4	-0.9	-1.5	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage	$I_D = -250\mu A$, referenced to 25°C		-3.8		mV/°C
ΔT_{J}	Temperature Coefficient					
r _{DS(on)}		$V_{GS} = -4.5V, I_D = -3.1A$		88	155	mΩ
	Drain to Source On Resistance	$V_{GS} = -2.5V, I_D = -2.3A$		144	220	
		$V_{GS} = -4.5V, I_D = -3.1A, T_J = 125^{\circ}C$		121	220	
9fs	Forward Transconductance	$V_{DS} = -5V, I_D = -3.1A$		6.2		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			340	450	pF
C _{oss}	Output Capacitance	─V _{DS} = −10V, V _{GS} = 0V, f = 1MHz		80	105	pF
C _{rss}	Reverse Transfer Capacitance			45	70	pF
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			5	10	ns
t _r	Rise Time	$-V_{DD} = -10V, I_D = -3.1A$		14	26	ns
t _{d(off)}	Turn-Off Delay Time	$-V_{GS} = -4.5V, R_{GEN} = 6\Omega$		13	24	ns
t _f	Fall Time			8	16	ns
Q _{g(TOT)}	Total Gate Charge at 4.5V	$V_{GS} = 0V \text{ to } -4.5V$ $V_{DD} = -10V$		3.4	4.8	nC
Q _{gs}	Gate to Source Gate Charge	I _D = -3.1A		0.8		nC
Q _{gd}	Gate to Drain "Miller" Charge			1.0		nC
Drain-So	urce Diode Characteristics					
I _S	Maximum Continuous Source-Drain Diode Forward				-1.1	Α
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = -1.1A$ (Note 2)		-0.8	-1.2	V
t _{rr}	Reverse Recovery Time			17	26	ns
Q _{rr}	Reverse Recovery Charge	- I _F = -3.1A, di/dt = 100A/μs		10	15	nC

FDMA1025P Dual P-Channel PowerTrench[®] MOSFET

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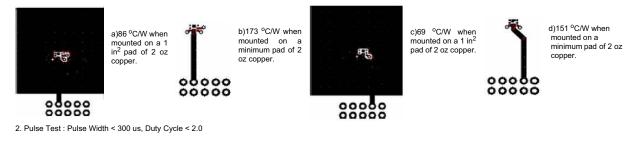
Notes:

1. R_{0JA} is determined with the device mounted on a 1 in² oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0JA} is determined by the (a) R_{0JA} = 66 °C/W when mounted on a 1 in² pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For single operation.

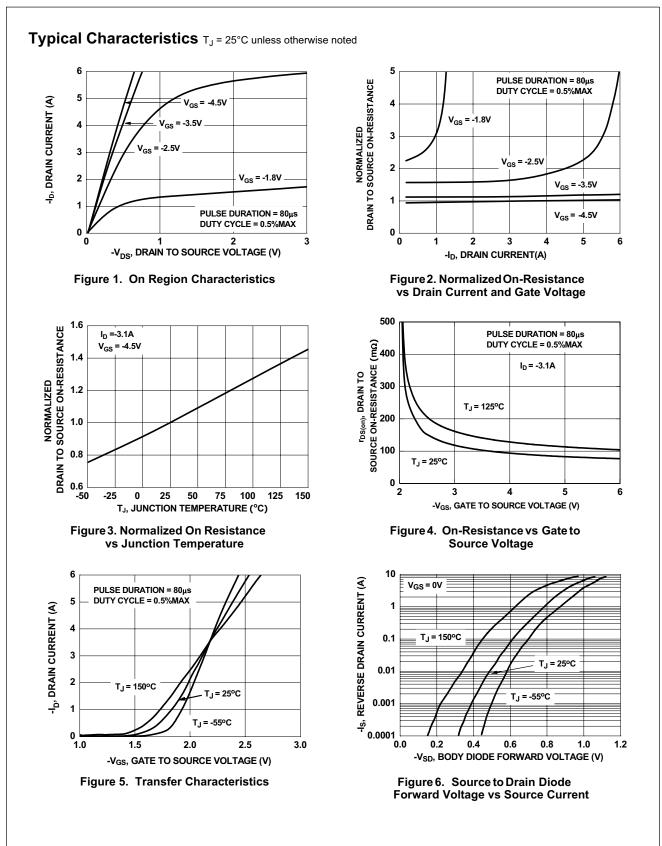
(b) $R_{\theta JA}$ = 173 °C/W when mounted on a minimum pad of 2 oz copper. For single operation.

(c) R_{0JA} = 69 °C/W when mounted on a 1 in² pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For dual operation.

(d) R_{0JA} = 151 °C/W when mounted on a minimum pad of 2 oz copper. For dual operation.



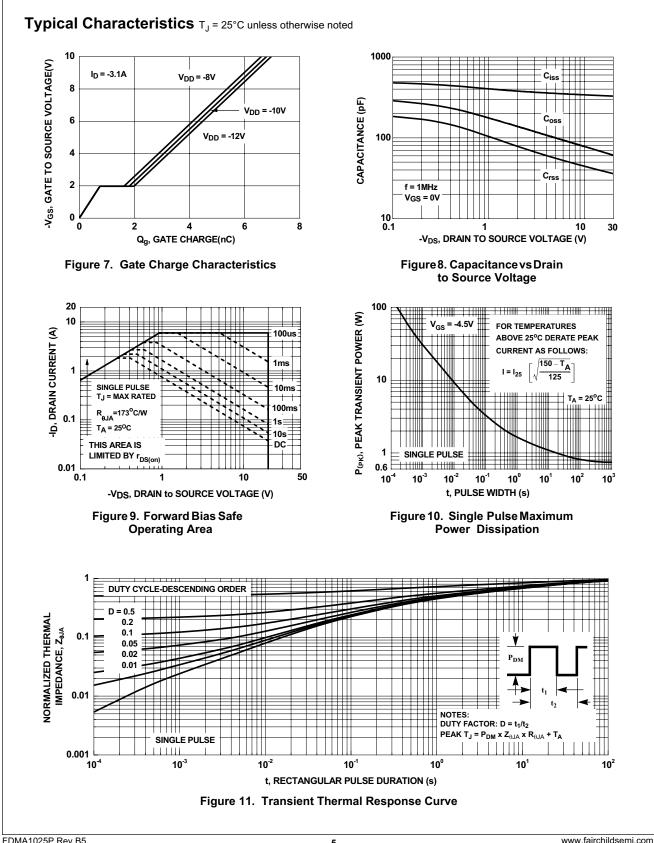
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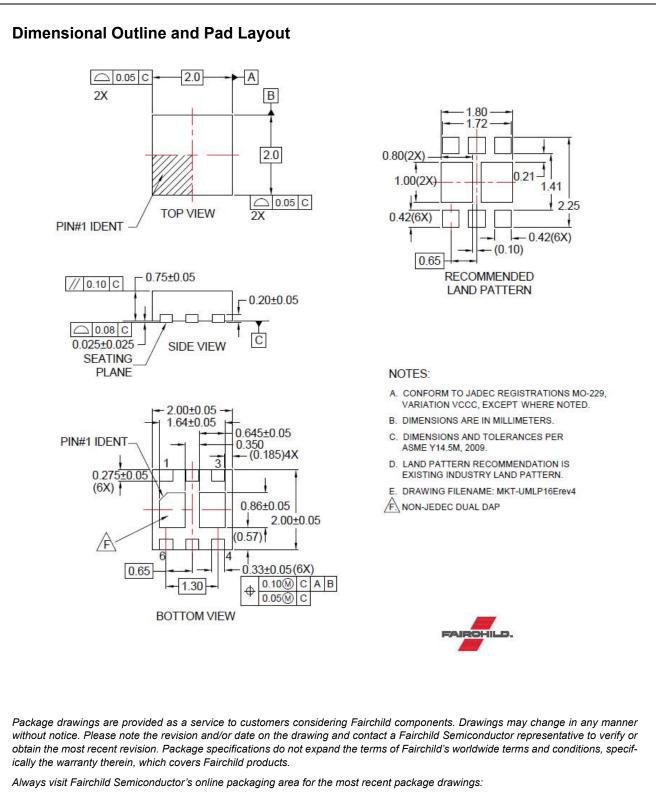
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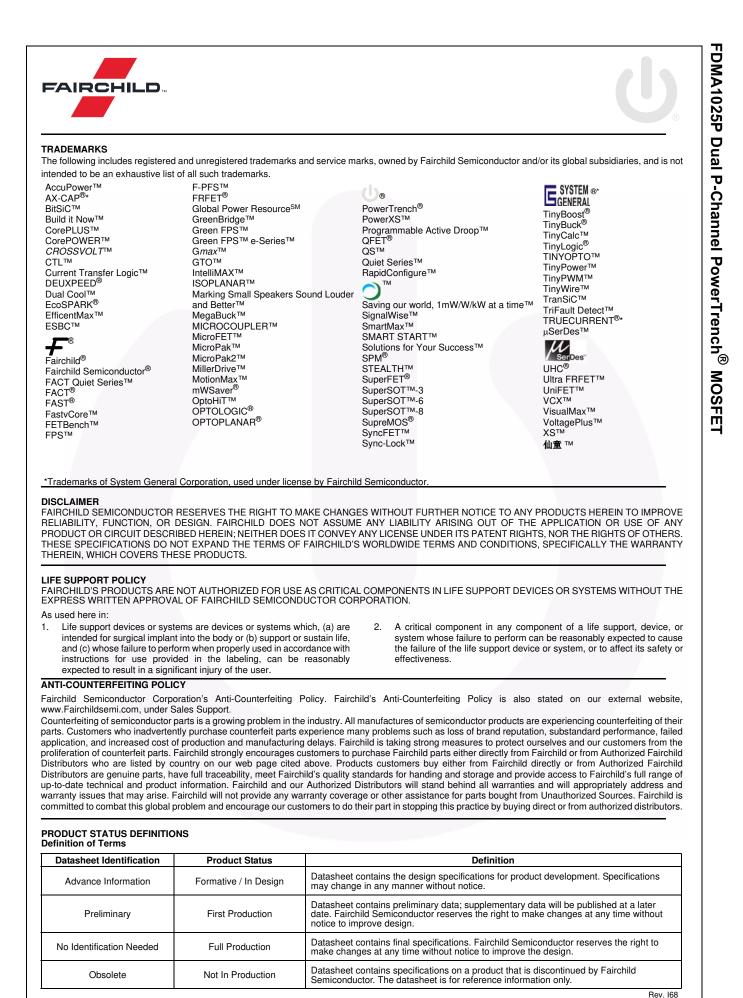
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